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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	32
Program Memory Size	3KB (2K x 12)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	134 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f59-i-pt

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



Flash-Based, 8-Bit CMOS Microcontroller Series

High-Performance RISC CPU:

- Only 33 single-word instructions to learn
- All instructions are single cycle except for program branches which are two-cycle
- Two-level deep hardware stack
- Direct, Indirect and Relative Addressing modes for data and instructions
- · Operating speed:
 - DC 20 MHz clock speed
 - DC 200 ns instruction cycle time
- On-chip Flash program memory:
 - 512 x 12 on PIC16F54
 - 2048 x 12 on PIC16F57
 - 2048 x 12 on PIC16F59
- General Purpose Registers (SRAM):
 - 25 x 8 on PIC16F54
 - 72 x 8 on PIC16F57
 - 134 x 8 on PIC16F59

Special Microcontroller Features:

- Power-on Reset (POR)
- Device Reset Timer (DRT)
- Watchdog Timer (WDT) with its own on-chip RC oscillator for reliable operation
- Programmable Code Protection
- Power-Saving Sleep mode
- In-Circuit Serial Programming[™] (ICSP[™])
- Selectable oscillator options:
 - RC: Low-cost RC oscillator
 - XT: Standard crystal/resonator
 - HS: High-speed crystal/resonator
 - LP: Power-saving, low-frequency crystal
- Packages:
 - 18-pin PDIP and SOIC for PIC16F54
 - 20-pin SSOP for PIC16F54
 - 28-pin PDIP, SOIC and SSOP for PIC16F57
 - 40-pin PDIP for PIC16F59
 - 44-pin TQFP for PIC16F59

Low-Power Features:

- Operating Current:
 - 170 μA @ 2V, 4 MHz, typical
 - 15 μA @ 2V, 32 kHz, typical
- Standby Current:
 - 500 nA @ 2V, typical

Peripheral Features:

- 12/20/32 I/O pins:
 - Individual direction control
 - High current source/sink
- 8-bit real-time clock/counter (TMR0) with 8-bit programmable prescaler

CMOS Technology:

- Wide operating voltage range:
 - Industrial: 2.0V to 5.5V
 - Extended: 2.0V to 5.5V
- Wide temperature range:
 - Industrial: -40°C to 85°C
 - Extended: -40°C to 125°C
- High-endurance Flash:
 - 100K write/erase cycles
 - > 40-year retention

Device	Program Memory	Data Memory	1/0	Timers 8-bit	
Device	Flash (words)	SRAM (bytes)	1/0		
PIC16F54	512	25	12	1	
PIC16F57	2048	72	20	1	
PIC16F59	2048	134	32	1	

NOTES:



FIGURE 2-1: PIC16F5X SERIES BLOCK DIAGRAM

3.6 Stack

The PIC16F54 device has a 9-bit wide, two-level hardware PUSH/POP stack. The PIC16F57 and PIC16F59 devices have an 11-bit wide, two-level hardware PUSH/POP stack.

A CALL instruction will PUSH the current value of stack 1 into stack 2 and then PUSH the current program counter value, incremented by one, into stack level 1. If more than two sequential CALL's are executed, only the most recent two return addresses are stored.

A RETLW instruction will POP the contents of stack level 1 into the program counter and then copy stack level 2 contents into level 1. If more than two sequential RETLW's are executed, the stack will be filled with the address previously stored in level 2.

Note:	The W register will be loaded with the					
	literal value specified in the instruction.					
	This is particularly useful for the					
	implementation of data look-up tables					
	within the program memory.					

For the RETLW instruction, the PC is loaded with the Top-of-Stack (TOS) contents. All of the devices covered in this data sheet have a two-level stack. The stack has the same bit width as the device PC, therefore, paging is not an issue when returning from a subroutine.

3.7 Indirect Data Addressing; INDF and FSR Registers

The INDF register is not a physical register. Addressing INDF actually addresses the register whose address is contained in the FSR Register (FSR is a *pointer*). This is indirect addressing.

EXAMPLE 3-1: INDIRECT ADDRESSING

- Register file 08 contains the value 10h
- Register file 09 contains the value 0Ah
- Load the value 08 into the FSR register
- A read of the INDF register will return the value of 10h
- Increment the value of the FSR register by one (FSR = 09h)
- A read of the INDF register now will return the value of 0Ah.

Reading INDF itself indirectly (FSR = 0) will produce 00h. Writing to the INDF register indirectly results in a no-operation (although Status bits may be affected).

A simple program to clear RAM locations 10h-1Fh using indirect addressing is shown in Example 3-2.

EXAMPLE 3-2: HOW TO CLEAR RAM USING INDIRECT ADDRESSING

NEXT	MOVLW MOVWF CLRF INCF	H'10' FSR INDF FSR,F	;initialize pointer ;to RAM ;clear INDF Register ;inc pointer
	BTFSC	FSR,4	;all done?
	GOTO	NEXT	;NO, clear next
CONTINUE			
	:		;YES, continue

The FSR is either a 5-bit (PIC16F54), 7-bit (PIC16F57) or 8-bit (PIC16F59) wide register. It is used in conjunction with the INDF register to indirectly address the data memory area.

The FSR<4:0> bits are used to select data memory addresses 00h to 1Fh.

PIC16F54: This does not use banking. FSR<7:5> bits are unimplemented and read as '1's.

PIC16F57: FSR<7> bit is unimplemented and read as '1'. FSR<6:5> are the bank select bits and are used to select the bank to be addressed (00 = Bank 0, 01 = Bank 1, 10 = Bank 2, 11 = Bank 3).

PIC16F59: FSR<7:5> are the bank select bits and are used to select the bank to be addressed (000 = Bank 0, 001 = Bank 1, 010 = Bank 2,

011 = Bank 3, 100 = Bank 4, 101 = Bank 5, 110 = Bank 6, 111 = Bank 7).

Note: A CLRF FSR instruction may not result in an FSR value of 00h if there are unimplemented bits present in the FSR.

5.0 RESET

The PIC16F5X devices may be reset in one of the following ways:

- Power-on Reset (POR)
- MCLR Reset (normal operation)
- MCLR Wake-up Reset (from Sleep)
- WDT Reset (normal operation)
- WDT Wake-up Reset (from Sleep)

Table 5-1 shows these Reset conditions for the PCL and STATUS registers.

Some registers are not affected in any Reset condition. Their status is unknown on POR and unchanged in any other Reset. Most other registers are reset to a "Reset state" on Power-on Reset (POR), MCLR or WDT Reset. A MCLR or WDT wake-up from Sleep also results in a device Reset and not a continuation of operation before Sleep. The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits (STATUS <4:3>) are set or cleared depending on the different Reset conditions (Table 5-1). These bits may be used to determine the nature of the Reset.

Table 5-3 lists a full description of Reset states of all registers. Figure 5-1 shows a simplified block diagram of the on-chip Reset circuit.

TABLE 5-1:STATUS BITS AND THEIR SIGNIFICANCE

Condition	то	PD
Power-on Reset	1	1
MCLR Reset (normal operation)	u	u
MCLR Wake-up (from Sleep)	1	0
WDT Reset (normal operation)	0	1
WDT Wake-up (from Sleep)	0	0

Legend: u = unchanged, x = unknown, — = unimplemented read as '0'.

TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH RESET

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	<u>Value</u> on MCLR and WDT Reset
03h	STATUS	PA2	PA1	PA0	TO	PD	Z	DC	С	0001 1xxx	000q quuu

Legend: u = unchanged, x = unknown, q = see Table 5-1 for possible values.

6.0 I/O PORTS

As with any other register, the I/O registers can be written and read under program control. However, read instructions (e.g., MOVF PORTB, W) always read the I/O pins independent of the pin's Input/Output modes. On Reset, all I/O ports are defined as input (inputs are at high-impedance), since the I/O control registers (TRISA, TRISB, TRISC, TRISD and TRISE) are all set.

6.1 PORTA

PORTA is a 4-bit I/O register. Only the low order 4 bits are used (PORTA<3:0>). The high order 4 bits (PORTA<7:4>) are unimplemented and read as '0's.

6.2 PORTB

PORTB is an 8-bit I/O register (PORTB<7:0>).

6.3 PORTC

PORTC is an 8-bit I/O register (PORTC<7:0>) for the PIC16F57 and PIC16F59.

PORTC is a General Purpose Register for the PIC16F54.

6.4 PORTD

PORTD is an 8-bit I/O register (PORTD<7:0>) for the PIC16F59.

PORTD is a General Purpose Register for the PIC16F54 and PIC16F57.

6.5 PORTE

PORTE is an 4-bit I/O register for the PIC16F59. Only the high order 4 bits are used (PORTE<7:4>). The low order 4 bits (PORTE<3:0>) are unimplemented and read as '0's.

PORTE is a General Purpose Register for the PIC16F54 and PIC16F57.

6.6 TRIS Registers

The output driver control registers are loaded with the contents of the W register by executing the TRIS f instruction. A '1' from a TRIS register bit puts the corresponding output driver in a High-Impedance (Input) mode. A '0' puts the contents of the output data latch on the selected pins, enabling the output buffer.

Note:	A read of the ports reads the pins, not the
	output data latches. That is, if an output
	driver on a pin is enabled and driven high,
	but the external system is holding it low, a
	read of the port will indicate that the pin is
	low.

The TRIS registers are "write-only" and are set (output drivers disabled) upon Reset.

6.7 I/O Interfacing

The equivalent circuit for an I/O port pin is shown in Figure 6-1. All ports may be used for both input and output operation. For input operations, these ports are non-latching. Any input must be present until read by an input instruction (e.g., MOVF PORTB, W). The outputs are latched and remain unchanged until the output latch is rewritten. To use a port pin as output, the corresponding direction control bit (in TRISA, TRISB, TRISC, TRISD and TRISE) must be cleared (= 0). For use as an input, the corresponding TRIS bit must be set. Any I/O pin can be programmed individually as input or output.

FIGURE 6-1:

EQUIVALENT CIRCUIT FOR A SINGLE I/O PIN



7.0 TIMER0 MODULE AND TMR0 REGISTER

The Timer0 module has the following features:

- 8-bit Timer/Counter register, TMR0
 - Readable and writable
- 8-bit software programmable prescaler
- Internal or external clock select
 - Edge select for external clock

Figure 7-1 is a simplified block diagram of the Timer0 module.

Timer mode is selected by clearing the T0CS bit (OPTION<5>). In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If TMR0 register is written, the increment is inhibited for the following two cycles (Figure 7-2 and Figure 7-3). The user can work around this by writing an adjusted value to the TMR0 register.

Counter mode is selected by setting the T0CS bit (OPTION<5>). In this mode, Timer0 will increment either on every rising or falling edge of pin T0CKI. The incrementing edge is determined by the source edge select bit T0SE (OPTION<4>). Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in **Section 7.1** "Using Timer0 with an External Clock".

Note: The prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both.

The prescaler assignment is controlled in software by the control bit PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4,..., 1:256 are selectable. **Section 7.2 "Prescaler**" details the operation of the prescaler.

A summary of registers associated with the Timer0 module is found in Table 7-1.



PC (Program	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4
Counter)	(PC - 1	PC	(PC + 1)	PC + 2	PC + 3	PC + 4	PC + 5	PC + 6
Instruction Fetch		MOVWF TMR0	MOVF TMR0,W					
								1 1
Timer0	Τ0 χ	Τ0 + 1 χ	Τ0 + 2 χ	NTO X	NTO X	ΝΤΟ Χ	NT0 + 1 X	NT0 + 2
Instruction Executed			Write TMR0 executed	Read TMR0 reads NT0	Read TMR0 reads NT0	Read TMR0 reads NT0	Read TMR0 reads NT0 + 1	Read TMR0 reads NT0 + 2

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8.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits that deal with the needs of realtime applications. The PIC16F5X family of microcontrollers have a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide powersaving operating modes and offer code protection. These features are:

- Oscillator Selection
- Reset
- Power-on Reset
- Device Reset Timer
- Watchdog Timer (WDT)
- Sleep
- Code protection
- User ID locations
- In-Circuit Serial Programming[™] (ICSP[™])

The PIC16F5X family has a Watchdog Timer which can be shut off only through Configuration bit WDTE. It runs off of its own RC oscillator for added reliability. There is an 18 ms delay provided by the Device Reset Timer (DRT), intended to keep the chip in Reset until the crystal oscillator is stable. With this timer on-chip, most applications need no external Reset circuitry.

REGISTER 8-1: CONFIGURATION WORD FOR PIC16F5X

_		_	_	_	_	_	_	CP	WDTE	FOSC1	FOSC0
bit 11											bit 0
bit 11-4:	Unimple	mented:	Read as ':	1'							
bit 3:	CP: Code	CP: Code Protection bit.									
	1 = Code	1 = Code protection off									
	0 = Code	0 = Code protection on									
bit 2:	WDTE: V	Vatchdog	Timer En	able bit							
	1 = WDT	[enabled									
	0 = WDI	disabled									
bit 1-0:	FOSC1:F	:0SC0 : 0	scillator S	Selection b	oits						
	00 = LP c	oscillator									
	01 = XI(0)	oscillator									
	11 = RC	oscillator									
	Note 1	: Refert	o the PIC	16F54. PI	C16F57 ar	nd PIC16F	59 Progra	mmina Sc	ecification	ns to deter	mine how
		to acce	ss the Co	onfiguratio	n Word. T	hese docu	iments ca	n be found	d on the M	icrochip w	eb site at
		www.m	licrocnip.c	com.							
	Legend:										
	R = Read	able bit	V	N = Writak	ole bit	U =	Unimplen	nented bit	. read as '	0'	
	-n = Value	e at POR	،	1' = bit is :	set	'O' =	= bit is clea	ared	x = bi	t is unknov	wn

The Sleep mode is designed to offer a very low-current Power-down mode. The user can wake-up from Sleep through external Reset or through a Watchdog Timer time-out. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost, while the LP crystal option saves power. A set of Configuration bits are used to select various options.

8.1 Configuration Bits

Configuration bits can be programmed to select various device configurations. Two bits are for the selection of the oscillator type; one bit is the Watchdog Timer enable bit; one bit is for code protection for the PIC16F5X devices (Register 8-1).

XORLW	Exclusive OR literal with W						
Syntax:	[<i>label</i>] XORLW k						
Operands:	$0 \le k \le 255$						
Operation:	(W) .XOR. $k \rightarrow (W)$						
Status Affected:	Z						
Encoding:	1111	kkkk	kkkk				
Description:	The contents of the W register are XOR'ed with the eight-bit literal 'k'. The result is placed in the W register.						
Words:	1						
Cycles:	1						
Example:	XORLW	0xAF					
Before Instruction W = 0xB5 After Instruction W = 0x1A							

CORWF Exclusive OR W with f					
Syntax:	[label]] XORWF	f, d		
Operands:	$0 \le f \le d \le [0, T]$	31 1]			
Operation:	(W) .X0	$OR.\ (f) \to (f)$	dest)		
Status Affected:	Z				
Encoding:	0001	10df	ffff		
	W regist '0', the registe stored	ster with re result is st r. If 'd' is '1 back in reg	gister 'f'. If 'd' is ored in the W ', the result is ister 'f'.		
Words:	1				
Cycles:	1				
Example:	XORWF	REG,1			
Before Instru	iction				
REG	=	0xAF			
W	=	0xB5			
After Instruct	ion				
REG	=	0x1A			
W	=	0xB5			

10.0 DEVELOPMENT SUPPORT

The PIC[®] microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
 - MPLAB® IDE Software
- Assemblers/Compilers/Linkers
 - MPASM[™] Assembler
 - MPLAB C18 and MPLAB C30 C Compilers
 - MPLINK[™] Object Linker/
 - MPLIB[™] Object Librarian
 - MPLAB ASM30 Assembler/Linker/Library
- Simulators
 - MPLAB SIM Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debugger
 - MPLAB ICD 2
- Device Programmers
 - PICSTART[®] Plus Development Programmer
 - MPLAB PM3 Device Programmer
 - PICkit[™] 2 Development Programmer
- Low-Cost Demonstration and Development Boards and Evaluation Kits

10.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit microcontroller market. The MPLAB IDE is a Windows[®] operating system-based application that contains:

- A single graphical interface to all debugging tools
 - Simulator
 - Programmer (sold separately)
 - Emulator (sold separately)
 - In-Circuit Debugger (sold separately)
- · A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- High-level source code debugging
- Visual device initializer for easy register initialization
- · Mouse over variable inspection
- Drag and drop variables from source to watch windows
- · Extensive on-line help
- Integration of select third party tools, such as HI-TECH Software C Compilers and IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PIC MCU emulator and simulator tools (automatically updates all project information)
- Debug using:
 - Source files (assembly or C)
 - Mixed assembly and C
 - · Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.

11.0 ELECTRICAL SPECIFICATIONS FOR PIC16F54/57

Absolute Maximum Ratings^(†)

Ambient Temperature under bias	40°C to +125°C
Storage Temperature	65°C to +150°C
Voltage on VDD with respect to Vss	0V to +6.5V
Voltage on MCLR with respect to Vss ⁽¹⁾	0V to +13.5V
Voltage on all other pins with respect to Vss	0.6V to (VDD + 0.6V)
Total power dissipation ⁽²⁾	800 mW
Max. current out of Vss pin	150 mA
Max. current into Vod pin	100 mA
Max. current into an input pin (T0CKI only)	±500 μA
Input clamp current, Iк (Vi < 0 or Vi > VDD)	±20 mA
Output clamp current, Iок (Vo < 0 or Vo > Voo)	±20 mA
Max. output current sunk by any I/O pin	25 mA
Max. output current sourced by any I/O pin	25 mA
Max. output current sourced by a single I/O port (PORTA, B or C)	50 mA
Max. output current sunk by a single I/O port (PORTA, B or C)	50 mA

- **Note 1:** Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50 to 100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.
 - 2: Power Dissipation is calculated as follows: Pdis = VDD x {IDD Σ IOH} + Σ {(VDD VOH) x IOH} + Σ (VOL x IOL)

†NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

11.1 DC Characteristics: PIC16F5X (Industrial)

DC CHARACTERISTICS				Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial				
Param No.	Sym.	Characteristic/Device	Min.	Тур†	Max.	Units	Conditions	
D001	Vdd	Supply Voltage	2.0	—	5.5	V		
D002	Vdr	RAM Data Retention Voltage ⁽¹⁾	—	1.5*	_	V	Device in Sleep mode	
D003	Vpor	VDD Start Voltage to ensure Power-on Reset	_	Vss	_	V	See Section 5.1 "Power-on Reset (POR)" for details on Power-on Reset	
D004	Svdd	VDD Rise Rate to ensure Power-on Reset	0.05*	-	-	V/ms	See Section 5.1 "Power-on Reset (POR)" for details on Power-on Reset	
D010	Idd	Supply Current ⁽²⁾						
			_	170	350	μA	Fosc = 4 MHz, VDD = 2.0V, XT or RC mode ⁽³⁾	
			-	0.4	1.0	mA	Fosc = 10 MHz, VDD = 3.0V, HS mode	
			-	1.7	5.0	mA	Fosc = 20 MHz, VDD = 5.0V, HS mode	
			_	15	22.5	μΑ	FOSC = 32 KHZ, VDD = 2.0V, LP mode,	
D020	IPD	Power-down Current ⁽²⁾		I	I			
			-	1.0	6.0	μA	VDD = 2.0V, WDT enabled	
			—	0.5	2.5	μA	VDD = 2.0V, WDT disabled	

* These parameters are characterized but not tested.

† Data in "Typ" column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: This is the limit to which VDD can be lowered in Sleep mode without losing RAM data.

- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature, also have an impact on the current consumption.
 - a) The test conditions for all IDD measurements in Active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to Vss, T0CKI = VDD, MCLR = VDD; WDT enabled/ disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in Sleep mode. The Power-down Current in Sleep mode does not depend on the oscillator type.
- 3: Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in k Ω .

DC CHARACTERISTICS				Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended				
Param No.	Sym.	Characteristic/Device	Min.	Тур†	Max.	Units	Conditions	
D001	Vdd	Supply Voltage	2.0		5.5	V		
D002	Vdr	RAM Data Retention Voltage ⁽¹⁾	—	1.5*	_	V	Device in Sleep mode	
D003	Vpor	VDD Start Voltage to ensure Power-on Reset	—	Vss	_	V	See Section 5.1 "Power-on Reset (POR)" for details on Power-on Reset	
D004	Svdd	VDD Rise Rate to ensure Power-on Reset	0.05*	_	_	V/ms	See Section 5.1 "Power-on Reset (POR)" for details on Power-on Reset	
D010	Idd	Supply Current ⁽²⁾						
			—	170	450	μΑ	Fosc = 4 MHz, VDD = 2.0V, XT or RC mode ⁽³⁾	
			—	0.4	2.0	mA	Fosc = 10 MHz, VDD = 3.0V, HS mode	
			—	1.7	7.0	mA	FOSC = 20 MHz, $VDD = 5.0V$, HS mode	
			—	15	40	μA	Fosc = 32 kHz, VDD = 2.0V, LP mode, WDT disabled	
D020	Ipd	Power-down Current ⁽²⁾						
			_	1.0	15.0	μA	VDD = 2.0V, WDT enabled	
			—	0.5	8.0	μA	VDD = 2.0V, WDT disabled	

11.2 DC Characteristics: PIC16F5X (Extended)

* These parameters are characterized but not tested.

† Data in "Typ" column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: This is the limit to which VDD can be lowered in Sleep mode without losing RAM data.

- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature, also have an impact on the current consumption.
 - a) The test conditions for all IDD measurements in Active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/ disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in Sleep mode. The Power-down Current in Sleep mode does not depend on the oscillator type.
- 3: Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in k Ω .

		Standard Operating Conditions (unless otherwise specified)						
	JIERISTICS	Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended						
Parameter No. Sym.		Characteristic	Min.	Тур†	Max.	Units	Conditions	
-	Fosc	External CLKIN Frequency ⁽¹⁾	DC		4.0	MHz	XT Osc mode	
			DC	—	20	MHz	HS Osc mode	
			DC	—	200	kHz	LP Osc mode	
		Oscillator Frequency ⁽¹⁾	DC	—	4.0	MHz	RC Osc mode	
			0.1	—	4.0	MHz	XT Osc mode	
			4.0	—	20	MHz	HS Osc mode	
			5.0	—	200	kHz	LP Osc mode	
1	Tosc	External CLKIN Period ⁽¹⁾	250	—		ns	XT Osc mode	
			50	—	—	ns	HS Osc mode	
			5.0	—	_	μs	LP Osc mode	
		Oscillator Period ⁽¹⁾	250	—	—	ns	RC Osc mode	
			250	—	10,000	ns	XT Osc mode	
			50	—	250	ns	HS Osc mode	
			5.0	—	_	μs	LP Osc mode	
2	TCY	Instruction Cycle Time ⁽²⁾	—	4/Fosc	_	—		
3	TosL, TosH	Clock in (OSC1) Low or High	50*	—	—	ns	XT oscillator	
		Time	20*	—	—	ns	HS oscillator	
			2.0*	—	_	μs	LP oscillator	
4	TosR, TosF	Clock in (OSC1) Rise or Fall	_		25*	ns	XT oscillator	
		Time	—	—	5*	ns	HS oscillator	
			—	—	50*	ns	LP oscillator	

TABLE 11-1: EXTERNAL CLOCK TIMING REQUIREMENTS

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

2: Instruction cycle period (TCY) equals four times the input oscillator time base period.





TABLE 11-4: TIMER0 CLOCK REQUIREMENTS – PIC16F5X

AC CHARACTERISTICS			$\begin{array}{ll} \mbox{Standard Operating Conditions (unless otherwise specified)} \\ \mbox{Operating Temperature} & -40^{\circ}\mbox{C} \leq \mbox{TA} \leq +85^{\circ}\mbox{C for industrial} \\ & -40^{\circ}\mbox{C} \leq \mbox{TA} \leq +125^{\circ}\mbox{C for extended} \end{array}$					
Param No.	Sym.	Characteristic	Min. Typ† Max. Units Conditions					
40	Tt0H	TOCKI High Pulse Width: No Prescaler With Prescaler	0.5 Tcy + 20* 10*			ns ns		
41	TtOL	T0CKI Low Pulse Width: No Prescaler With Prescaler	0.5 Tcy + 20* 10*			ns ns		
42	Tt0P	T0CKI Period	20 or <u>Tcy + 40</u> * N		—	ns	Whichever is greater. N = Prescale Value (1, 2, 4,, 256)	

These parameters are characterized but not tested.

Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for † design guidance only and are not tested.



28-Lead SOIC

44-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS	5
Dime	ension Limits	MIN	NOM	MAX
Number of Leads	N		44	
Lead Pitch	е		0.80 BSC	
Overall Height	А	_	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	-	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1	1.00 REF		
Foot Angle	φ	0°	3.5°	7°
Overall Width	E	12.00 BSC		
Overall Length	D	12.00 BSC		
Molded Package Width	E1		10.00 BSC	
Molded Package Length	D1	10.00 BSC		
Lead Thickness	С	0.09	-	0.20
Lead Width	b	0.30	0.37	0.45
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.

- 4. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-076B

Q

Q cycles	2
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R

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